



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

	BV _{DSS}	R _{DS(ON)} Max	I _D Tc = +25°C
	60V	$2m\Omega$ @ $V_{GS} = 10V$	205A
		$3.3 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	165A

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6002LPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

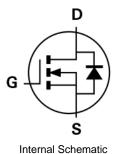
https://www.diodes.com/quality/product-definitions/

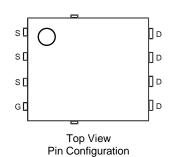
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208[®]
- Weight: 0.097 grams (Approximate)



PowerDI5060-8 (SWP) (Standard)





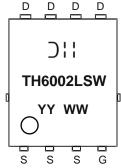
Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH6002LPSWQ-13	PowerDI5060-8 (SWP) (Standard)	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



TH6002LSW = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 21 = 2021)
WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	60	V	
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) $T_{C} = +25$ $T_{C} = +100$		l _D	205 145	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	820	A	
Maximum Continuous Body Diode Forward Current (Note 6)	$T_C = +25^{\circ}C$	ls	205	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1	lsм	820	Α	
Avalanche Current, L = 3mH	las	21	Α	
Avalanche Energy, L = 3mH	E _{AS}	662	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3	W
Thermal Resistance, Junction to Ambient (Note 5) Steady State		RθJA	50	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	P _D	167	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	0.9	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

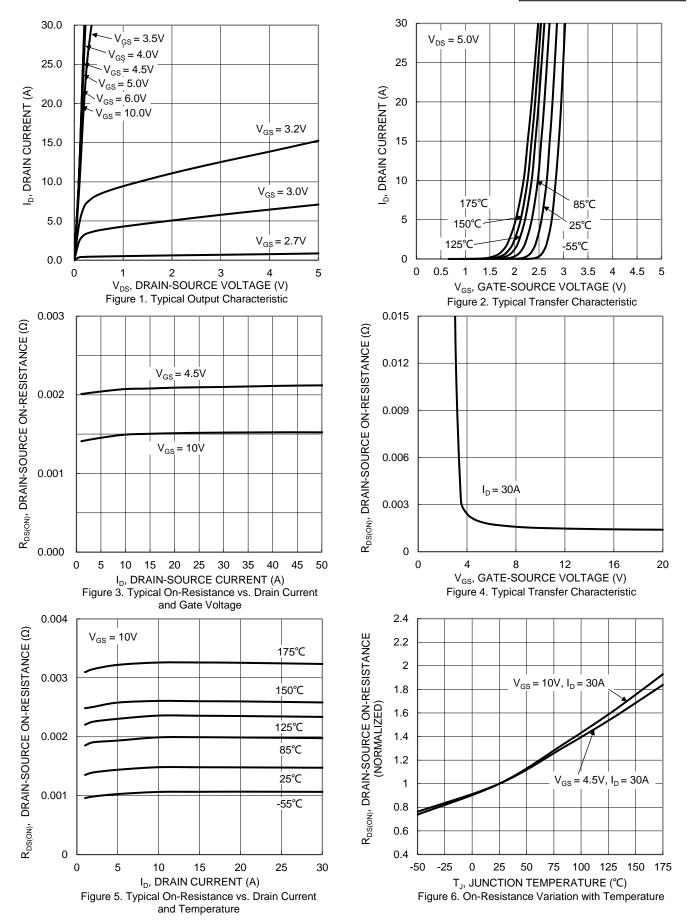
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						rest condition	
Drain-Source Breakdown Voltage	BVpss	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	Ipss	_	_	1	μA	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	1	_	3	V	V _{DS} = V _{GS} , I _D = 250μA	
Olatia Basia Ossasa Os Basialasa	_	_	1.5	2	mΩ	V _{GS} = 10V, I _D = 30A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2.1	3.3		Vgs = 4.5V, ID = 30A	
Diode Forward Voltage	VsD		0.8	1.2	V	Vgs = 0V, Is = 30A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	8289	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	2467	_	pF		
Reverse Transfer Capacitance	Crss	_	179	_			
Gate Resistance	Rg	_	0.76	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	68	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	131		nC	Vps = 30V, Ip = 50A	
Gate-Source Charge	Qgs	_	20.3	_	nc	VDS = 30V, ID = 50A	
Gate-Drain Charge	Qgd	_	30.5	_			
Turn-On Delay Time	td(on)	_	9.8	_			
Turn-On Rise Time	t _R	_	17.1	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$	
Turn-Off Delay Time	tD(OFF)	_	67.3		115	$I_D=50A,\ R_g=2.5\Omega$	
Turn-Off Fall Time	tF	_	32.9	_			
Body Diode Reverse Recovery Time	t _{RR}	_	67	_	ns	I_ 500 di/dt 1000/us	
Body Diode Reverse Recovery Charge	Qrr	_	141	_	nC	I _F = 50A, di/dt = 100A/μs	

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.











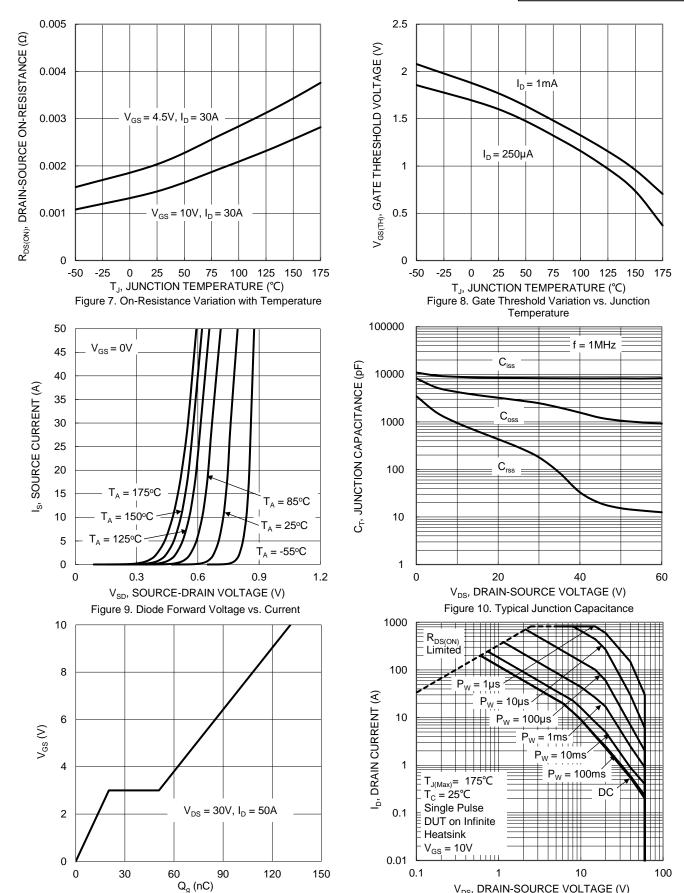


Figure 11. Gate Charge

 V_{DS} , DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



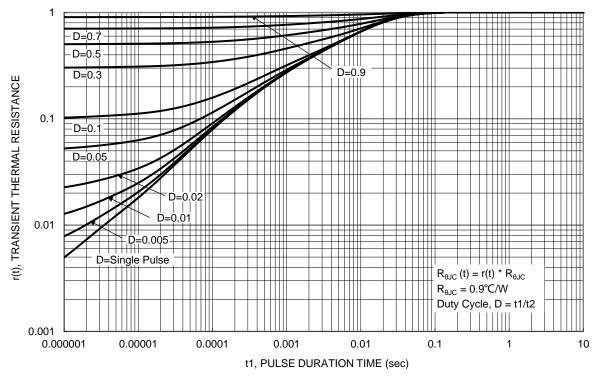


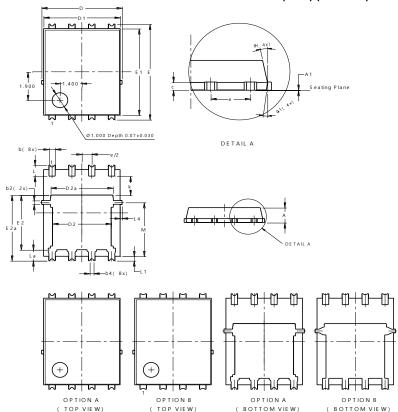
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Standard)

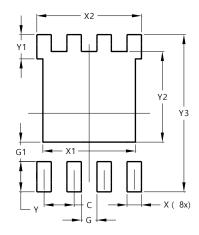


PowerDI5060-8 (SWP)					
(Standard)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	0.25REF				
С	0.230	0.330	0.277		
D	5.15 BSC				
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78 4.18		3.98		
Е	6	.40 BS0)		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635 0.835		0.735		
La	La 0.635 0.8		0.735		
L1	L1 0.200		0.300		
L4	0.025	0.225	0.125		
M	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Standard)



Dimensions	Value			
פווטופווטוט	(in mm)			
C	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	4.100			
X2	4.420			
Y	1.270			
Y1	1.020			
Y2	3.810			
Y3	6.610			



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